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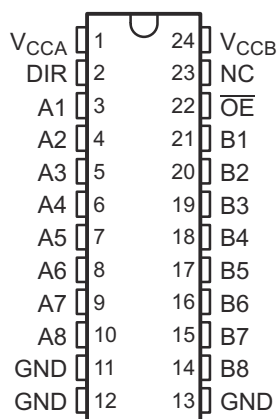
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Changes from Revision P (December 2015) to Revision Q (December 2022)</b>                                                                                                                                                                                                                                                                                                                                      | <b>Page</b> |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| • Updated the numbering format for tables, figures, and cross-references throughout the document.....                                                                                                                                                                                                                                                                                                             | <b>1</b>    |
| • Added thermal information for DB and PW package.....                                                                                                                                                                                                                                                                                                                                                            | <b>6</b>    |
| • Added inclusive terminology.....                                                                                                                                                                                                                                                                                                                                                                                | <b>15</b>   |
| <b>Changes from Revision O (March 2005) to Revision P (December 2015)</b>                                                                                                                                                                                                                                                                                                                                         | <b>Page</b> |
| • Added <i>Applications</i> section, <i>Device Information</i> table, <i>ESD Ratings</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section..... | <b>1</b>    |
| • Removed <i>Ordering Information</i> table.....                                                                                                                                                                                                                                                                                                                                                                  | <b>1</b>    |

## 5 Pin Configuration and Functions



NC – No internal connection

See [Section 12](#) for dimensions.

**Figure 5-1. DB, DBQ, DW, NS, or PW Package, 24-Pin SSOP, SOIC, SO, or TSSOP (Top View)**

**Table 5-1. Pin Functions**

| PIN              |     | TYPE <sup>(1)</sup> | DESCRIPTION              |
|------------------|-----|---------------------|--------------------------|
| NAME             | NO. |                     |                          |
| A1               | 3   | I/O                 | A1 port                  |
| A2               | 4   | I/O                 | A2 port                  |
| A3               | 5   | I/O                 | A3 port                  |
| A4               | 6   | I/O                 | A4 port                  |
| A5               | 7   | I/O                 | A5 port                  |
| A6               | 8   | I/O                 | A6 port                  |
| A7               | 9   | I/O                 | A7 port                  |
| A8               | 10  | I/O                 | A8 port                  |
| B1               | 21  | I/O                 | B1 port                  |
| B2               | 20  | I/O                 | B2 port                  |
| B3               | 19  | I/O                 | B3 port                  |
| B4               | 18  | I/O                 | B4 port                  |
| B5               | 17  | I/O                 | B5 port                  |
| B6               | 16  | I/O                 | B6 port                  |
| B7               | 15  | I/O                 | B7 port                  |
| B8               | 14  | I/O                 | B8 port                  |
| DIR              | 2   | I                   | Dir input                |
| GND              | 11  | —                   | Ground                   |
|                  | 12  |                     |                          |
|                  | 13  |                     |                          |
| NC               | 23  | —                   | Unconnected              |
| OE               | 22  | I                   | Output Enable active low |
| V <sub>CCA</sub> | 1   | —                   | A port power             |
| V <sub>CCB</sub> | 24  | —                   | B port power             |

(1) I = input, O = output, P = power

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                        |                                                           | MIN                             | MAX             | UNIT |
|------------------------|-----------------------------------------------------------|---------------------------------|-----------------|------|
| $V_{CCA}$<br>$V_{CCB}$ | Supply voltage                                            | −0.5                            | 6               | V    |
| $V_I$                  | Input voltage                                             | All A ports <sup>(2)</sup>      | $V_{CCA} + 0.5$ | V    |
|                        |                                                           | All B ports <sup>(3)</sup>      | $V_{CCB} + 0.5$ |      |
|                        |                                                           | Except I/O ports <sup>(2)</sup> | $V_{CCA} + 0.5$ |      |
| $V_O$                  | Output voltage <sup>(3)</sup>                             | All A ports                     | $V_{CCA} + 0.5$ | V    |
|                        |                                                           | All B ports                     | $V_{CCB} + 0.5$ |      |
| $I_{IK}$               | Input clamp current                                       | $V_I < 0$                       | −50             | mA   |
| $I_{OK}$               | Output clamp current                                      | $V_O < 0$                       | −50             | mA   |
| $I_O$                  | Continuous output current                                 |                                 | ±50             | mA   |
|                        | Continuous current through $V_{CCA}$ , $V_{CCB}$ , or GND |                                 | ±100            | mA   |
| $T_J$                  | Junction temperature                                      |                                 | 150             | °C   |
| $R_{\theta JA}$        | Junction-to-ambient thermal resistance                    | DW                              | 46              | °C/W |
|                        |                                                           | NS                              | 65              |      |
| $T_{stg}$              | Storage temperature                                       | −65                             | 150             | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) This value is limited to 4.6 V maximum.

(3) This value is limited to 6 V maximum.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

### 6.2 ESD Ratings

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

|           |                          | $V_{CCA}$ | $V_{CCB}$ | MIN  | NOM | MAX | UNIT |
|-----------|--------------------------|-----------|-----------|------|-----|-----|------|
| $V_{CCA}$ | Supply voltage           |           |           | 2.3  | 3.3 | 3.6 | V    |
| $V_{CCB}$ | Supply voltage           |           |           | 3    | 5   | 5.5 | V    |
| $V_{IHA}$ | High-level input voltage | 2.3 V     | 3 V       | 1.7  |     |     | V    |
|           |                          | 2.7 V     | 3 V       | 2    |     |     |      |
|           |                          | 3 V       | 3.6 V     | 2    |     |     |      |
|           |                          | 3.6 V     | 5.5 V     | 2    |     |     |      |
| $V_{IHB}$ | High-level input voltage | 2.3 V     | 3 V       | 2    |     |     | V    |
|           |                          | 2.7 V     | 3 V       | 2    |     |     |      |
|           |                          | 3 V       | 3.6 V     | 2    |     |     |      |
|           |                          | 3.6 V     | 5.5 V     | 3.85 |     |     |      |

### 6.3 Recommended Operating Conditions (continued)

|                  |                                                                                   | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN | NOM | MAX              | UNIT |
|------------------|-----------------------------------------------------------------------------------|------------------|------------------|-----|-----|------------------|------|
| V <sub>ILA</sub> | Low-level input voltage                                                           | 2.3 V            | 3 V              |     |     | 0.7              | V    |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | 0.8              |      |
|                  |                                                                                   | 3 V              | 3.6 V            |     |     | 0.8              |      |
|                  |                                                                                   | 3.6 V            | 5.5 V            |     |     | 0.8              |      |
| V <sub>ILB</sub> | Low-level input voltage                                                           | 2.3 V            | 3 V              |     |     | 0.8              | V    |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | 0.8              |      |
|                  |                                                                                   | 3 V              | 3.6 V            |     |     | 0.8              |      |
|                  |                                                                                   | 3.6 V            | 5.5 V            |     |     | 1.65             |      |
| V <sub>IH</sub>  | High-level input voltage (control terminals)<br>(referenced to V <sub>CCA</sub> ) | 2.3 V            | 3 V              | 1.7 |     |                  | V    |
|                  |                                                                                   | 2.7 V            | 3 V              | 2   |     |                  |      |
|                  |                                                                                   | 3 V              | 3.6 V            | 2   |     |                  |      |
|                  |                                                                                   | 3.6 V            | 5.5 V            | 2   |     |                  |      |
| V <sub>IL</sub>  | Low-level input voltage (control terminals)<br>(referenced to V <sub>CCA</sub> )  | 2.3 V            | 3 V              |     |     | 0.7              | V    |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | 0.8              |      |
|                  |                                                                                   | 3 V              | 3.6 V            |     |     | 0.8              |      |
|                  |                                                                                   | 3.6 V            | 5.5 V            |     |     | 0.8              |      |
| V <sub>IA</sub>  | Input voltage                                                                     |                  |                  | 0   |     | V <sub>CCA</sub> | V    |
| V <sub>IB</sub>  | Input voltage                                                                     |                  |                  | 0   |     | V <sub>CCB</sub> | V    |
| V <sub>OA</sub>  | Output voltage                                                                    |                  |                  | 0   |     | V <sub>CCA</sub> | V    |
| V <sub>OB</sub>  | Output voltage                                                                    |                  |                  | 0   |     | V <sub>CCB</sub> | V    |
| I <sub>OHA</sub> | High-level output current                                                         | 2.3 V            | 3 V              |     |     | –8               | mA   |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | –12              |      |
|                  |                                                                                   | 3 V              | 3 V              |     |     | –24              |      |
|                  |                                                                                   | 2.7 V            | 4.5 V            |     |     | –24              |      |
| I <sub>OHB</sub> | High-level output current                                                         | 2.3 V            | 3 V              |     |     | –12              | mA   |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | –12              |      |
|                  |                                                                                   | 3 V              | 3 V              |     |     | –24              |      |
|                  |                                                                                   | 2.7 V            | 4.5 V            |     |     | –24              |      |
| I <sub>OLA</sub> | Low-level output current                                                          | 2.3 V            | 3 V              |     |     | 8                | mA   |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | 12               |      |
|                  |                                                                                   | 3 V              | 3 V              |     |     | 24               |      |
|                  |                                                                                   | 2.7 V            | 4.5 V            |     |     | 24               |      |
| I <sub>OLB</sub> | Low-level output current                                                          | 2.3 V            | 3 V              |     |     | 12               | mA   |
|                  |                                                                                   | 2.7 V            | 3 V              |     |     | 12               |      |
|                  |                                                                                   | 3 V              | 3 V              |     |     | 24               |      |
|                  |                                                                                   | 2.7 V            | 4.5 V            |     |     | 24               |      |
| Δt/Δv            | Input transition rise or fall rate                                                |                  |                  |     |     | 10               | ns/V |
| T <sub>A</sub>   | Operating free-air temperature                                                    |                  |                  | –40 |     | 85               | °C   |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1) (4)</sup> |                                              | SN74LVCC3245A |            |            | UNIT |
|-----------------------------------|----------------------------------------------|---------------|------------|------------|------|
|                                   |                                              | DB (SSOP)     | DBQ (SSOP) | PW (TSSOP) |      |
|                                   |                                              | 24 PINS       | 24 PINS    | 24 PINS    |      |
| $R_{\theta JA}$                   | Junction-to-ambient thermal resistance       | 90.7          | 61         | 100.6      | °C/W |
| $R_{\theta JC(top)}$              | Junction-to-case (top) thermal resistance    | 51.9          | 44.8       | 44.7       | °C/W |
| $R_{\theta JB}$                   | Junction-to-board thermal resistance         | 49.7          | 34.5       | 55.8       | °C/W |
| $\psi_{JT}$                       | Junction-to-top characterization parameter   | 18.8          | 9.5        | 6.8        | °C/W |
| $\psi_{JB}$                       | Junction-to-board characterization parameter | 49.3          | 37.2       | 55.4       | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER               |                | TEST CONDITIONS                                      | $V_{CCA}$ | $V_{CCB}$ | MIN       | TYP     | MAX | UNIT    |
|-------------------------|----------------|------------------------------------------------------|-----------|-----------|-----------|---------|-----|---------|
| $V_{OHA}$               |                | $I_{OH} = -100 \mu A$                                | 3 V       | 3 V       | 2.9       | 3       |     | V       |
|                         |                | $I_{OH} = -8 \text{ mA}$                             | 2.3 V     | 3 V       | 2         |         |     |         |
|                         |                | $I_{OH} = -12 \text{ mA}$                            | 2.7 V     | 3 V       | 2.2       | 2.5     |     |         |
|                         |                |                                                      | 3 V       | 3 V       | 2.4       | 2.8     |     |         |
|                         |                | $I_{OH} = -24 \text{ mA}$                            | 3 V       | 3 V       | 2.2       | 2.6     |     |         |
|                         |                |                                                      | 2.7 V     | 4.5 V     | 2         | 2.3     |     |         |
| $V_{OHB}$               |                | $I_{OH} = -100 \mu A$                                | 3 V       | 3 V       | 2.9       | 3       |     | V       |
|                         |                | $I_{OH} = -12 \text{ mA}$                            | 2.3 V     | 3 V       | 2.4       |         |     |         |
|                         |                |                                                      | 2.7 V     | 3 V       | 2.4       | 2.8     |     |         |
|                         |                | $I_{OH} = -24 \text{ mA}$                            | 3 V       | 3 V       | 2.2       | 2.6     |     |         |
|                         |                |                                                      | 2.7 V     | 4.5 V     | 3.2       | 4.2     |     |         |
|                         |                |                                                      |           |           |           |         |     |         |
| $V_{OLA}$               |                | $I_{OL} = 100 \mu A$                                 | 3 V       | 3 V       |           |         | 0.1 | V       |
|                         |                | $I_{OL} = 8 \text{ mA}$                              | 2.3 V     | 3 V       |           |         | 0.6 |         |
|                         |                | $I_{OL} = 12 \text{ mA}$                             | 2.7 V     | 3 V       |           | 0.1     | 0.5 |         |
|                         |                | $I_{OL} = 24 \text{ mA}$                             | 3 V       | 3 V       |           | 0.2     | 0.5 |         |
|                         |                |                                                      | 2.7 V     | 4.5 V     |           | 0.2     | 0.5 |         |
|                         |                |                                                      |           |           |           |         |     |         |
| $V_{OLB}$               |                | $I_{OL} = 100 \mu A$                                 | 3 V       | 3 V       |           |         | 0.1 | V       |
|                         |                | $I_{OL} = 12 \text{ mA}$                             | 2.3 V     | 3 V       |           |         | 0.4 |         |
|                         |                | $I_{OL} = 24 \text{ mA}$                             | 3 V       | 3 V       |           | 0.2     | 0.5 |         |
|                         |                |                                                      | 2.7 V     | 4.5 V     |           | 0.2     | 0.5 |         |
|                         |                |                                                      |           |           |           |         |     |         |
|                         |                |                                                      |           |           |           |         |     |         |
| $I_I$                   | Control inputs | $V_I = V_{CCA}$ or GND                               | 3.6 V     | 3.6 V     | $\pm 0.1$ | $\pm 1$ |     | $\mu A$ |
|                         |                |                                                      |           | 5.5 V     | $\pm 0.1$ | $\pm 1$ |     |         |
| $I_{OZ}$ <sup>(1)</sup> | A or B ports   | $V_O = V_{CCA/B}$ or GND, $V_I = V_{IL}$ or $V_{IH}$ | 3.6 V     | 3.6 V     | $\pm 0.5$ | $\pm 5$ |     | $\mu A$ |
| $I_{CCA}$               | B to A         | A port = $V_{CCA}$ or GND, $I_O = 0$                 | 3.6 V     | Open      |           | 5       | 50  | $\mu A$ |
|                         |                | B port = $V_{CCB}$ or GND, $I_O = 0$                 | 3.6 V     | 3.6 V     |           | 5       | 50  |         |
|                         |                |                                                      |           | 5.5 V     |           | 5       | 50  |         |
| $I_{CCB}$               | A to B         | A port = $V_{CCA}$ or GND, $I_O = 0$                 | 3.6 V     | 3.6 V     |           | 5       | 50  | $\mu A$ |
|                         |                |                                                      |           | 5.5 V     |           | 8       | 80  |         |

## 6.5 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER            |                 | TEST CONDITIONS                                                                                                                        | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN | TYP  | MAX | UNIT |
|----------------------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------|------------------|------------------|-----|------|-----|------|
| $\Delta I_{CCA}$ (2) | A port          | V <sub>I</sub> = V <sub>CCA</sub> – 0.6 V, Other inputs at V <sub>CCA</sub> or GND, $\overline{OE}$ at GND and DIR at V <sub>CCA</sub> | 3.6 V            | 3.6 V            |     | 0.35 | 0.5 | mA   |
|                      | $\overline{OE}$ | V <sub>I</sub> = V <sub>CCA</sub> – 0.6 V, Other inputs at V <sub>CCA</sub> or GND, DIR at V <sub>CCA</sub>                            | 3.6 V            | 3.6 V            |     | 0.35 | 0.5 |      |
|                      | DIR             | V <sub>I</sub> = V <sub>CCA</sub> – 0.6 V, Other inputs at V <sub>CCA</sub> or GND, $\overline{OE}$ at GND                             | 3.6 V            | 3.6 V            |     | 0.35 | 0.5 |      |
| $\Delta I_{CCB}$ (2) | B port          | V <sub>I</sub> = V <sub>CCB</sub> – 2.1 V, Other inputs at V <sub>CCB</sub> or GND, $\overline{OE}$ at GND and DIR at GND              | 3.6 V            | 5.5 V            |     | 1    | 1.5 | mA   |
| C <sub>i</sub>       | Control inputs  | V <sub>I</sub> = V <sub>CCA</sub> or GND                                                                                               | Open             | Open             |     | 4    |     | pF   |
| C <sub>io</sub>      | A or B ports    | V <sub>O</sub> = V <sub>CCA/B</sub> or GND                                                                                             | 3.3 V            | 5 V              |     | 18.5 |     | pF   |

(1) For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

(2) This is the increase in supply current for each input that is at one of the specified voltage levels, rather than 0 V or the associated V<sub>CC</sub>.

## 6.6 Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 7-1 through Figure 7-4)

| PARAMETER        | FROM (INPUT)    | TO (OUTPUT) | V <sub>CCA</sub> , V <sub>CCB</sub>                                 | MIN | MAX  | UNIT |
|------------------|-----------------|-------------|---------------------------------------------------------------------|-----|------|------|
| t <sub>PHL</sub> | A               | B           | V <sub>CCA</sub> = 2.5 V ± 0.2 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V  | 1   | 9.4  | ns   |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 5 V ± 0.5 V   | 1   | 6    |      |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V | 1   | 7.1  |      |
| t <sub>PLH</sub> | A               | B           | V <sub>CCA</sub> = 2.5 V ± 0.2 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V  | 1   | 9.1  | ns   |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 5 V ± 0.5 V   | 1   | 5.3  |      |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V | 1   | 7.2  |      |
| t <sub>PHL</sub> | B               | A           | V <sub>CCA</sub> = 2.5 V ± 0.2 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V  | 1   | 11.2 | ns   |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 5 V ± 0.5 V   | 1   | 5.8  |      |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V | 1   | 6.4  |      |
| t <sub>PLH</sub> | B               | A           | V <sub>CCA</sub> = 2.5 V ± 0.2 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V  | 1   | 9.9  | ns   |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 5 V ± 0.5 V   | 1   | 7    |      |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V | 1   | 7.6  |      |
| t <sub>PZL</sub> | $\overline{OE}$ | A           | V <sub>CCA</sub> = 2.5 V ± 0.2 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V  | 1   | 14.5 | ns   |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 5 V ± 0.5 V   | 1   | 9.2  |      |
|                  |                 |             | V <sub>CCA</sub> = 2.7 V TO 3.6 V, V <sub>CCB</sub> = 3.3 V ± 0.3 V | 1   | 9.7  |      |

## 6.6 Switching Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 7-1 through Figure 7-4)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCA}, V_{CCB}$                                                                 | MIN | MAX  | UNIT |
|-----------|-----------------|----------------|------------------------------------------------------------------------------------|-----|------|------|
| $t_{PZH}$ | $\overline{OE}$ | A              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 12.9 | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 9.5  |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 9.5  |      |
| $t_{PZL}$ | $\overline{OE}$ | B              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 13   | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 8.1  |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 9.2  |      |
| $t_{PZH}$ | $\overline{OE}$ | B              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 12.8 | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 8.4  |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 9.9  |      |
| $t_{PLZ}$ | $\overline{OE}$ | A              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 7.1  | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 7    |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 6.6  |      |
| $t_{PHZ}$ | $\overline{OE}$ | A              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 7.3  | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 7.8  |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 6.9  |      |
| $t_{PLZ}$ | $\overline{OE}$ | B              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 8.8  | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 7.3  |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 7.5  |      |
| $t_{PHZ}$ | $\overline{OE}$ | B              | $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 8.9  | ns   |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$   | 1   | 7    |      |
|           |                 |                | $V_{CCA} = 2.7\text{ V TO } 3.6\text{ V}, V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1   | 7.9  |      |

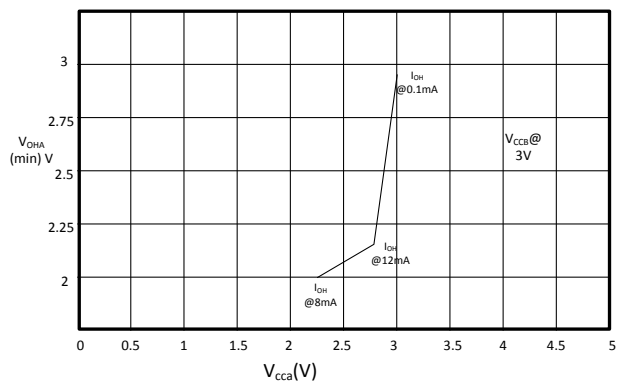
## 6.7 Operating Characteristics

$V_{CCA} = 3.3\text{ V}, V_{CCB} = 5\text{ V}, T_A = 25^\circ\text{C}$

| PARAMETER |                                               |                  | TEST CONDITIONS                     | TYP | UNIT |
|-----------|-----------------------------------------------|------------------|-------------------------------------|-----|------|
| $C_{pd}$  | Power dissipation capacitance per transceiver | Outputs enabled  | $C_L = 50, \quad f = 10\text{ MHz}$ | 38  | pF   |
|           |                                               | Outputs disabled |                                     | 4.5 |      |



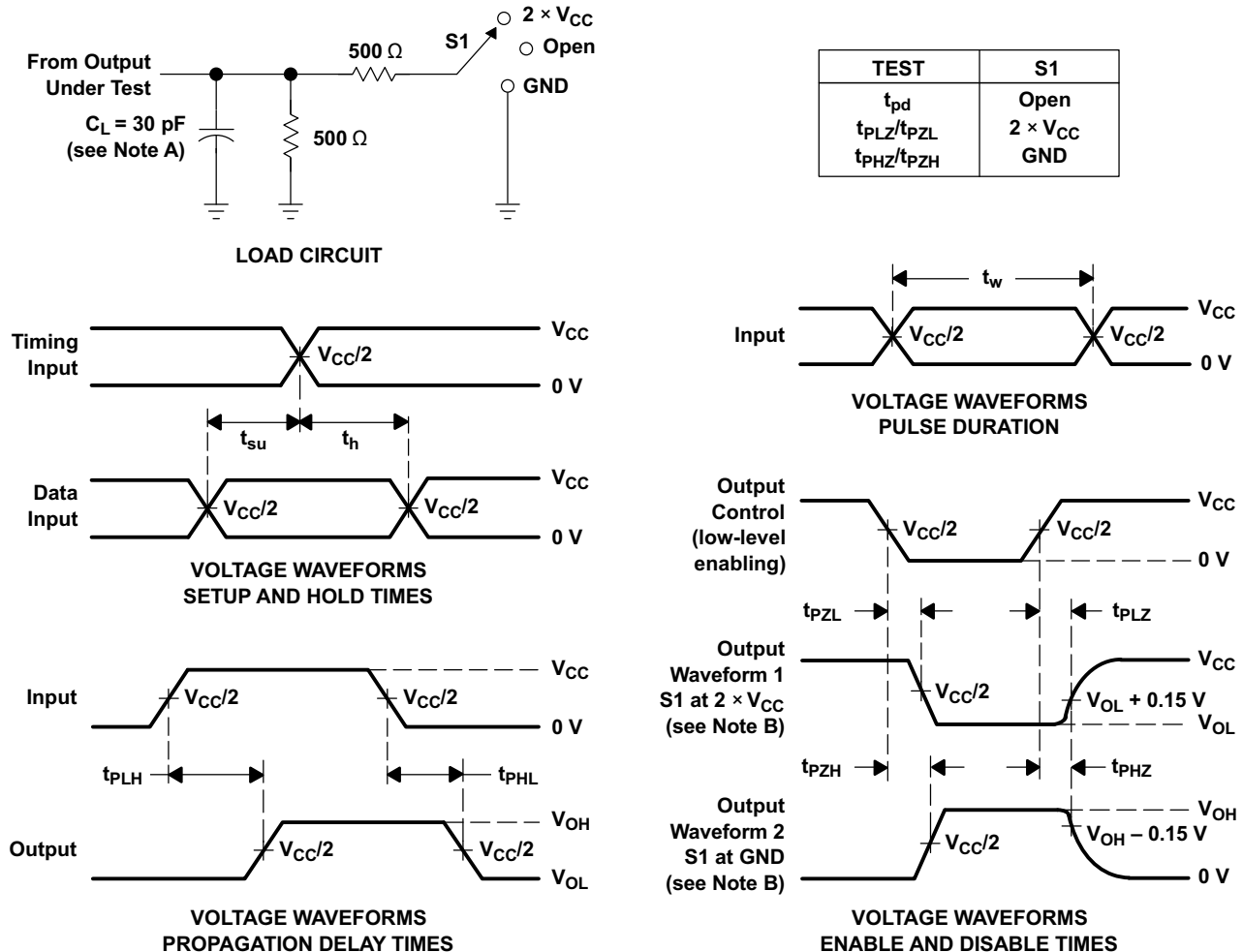
## 6.8 Typical Characteristics



**Figure 6-1.  $V_{OHA(min)}$  VS  $V_{CCA}$**

## 7 Parameter Measurement Information

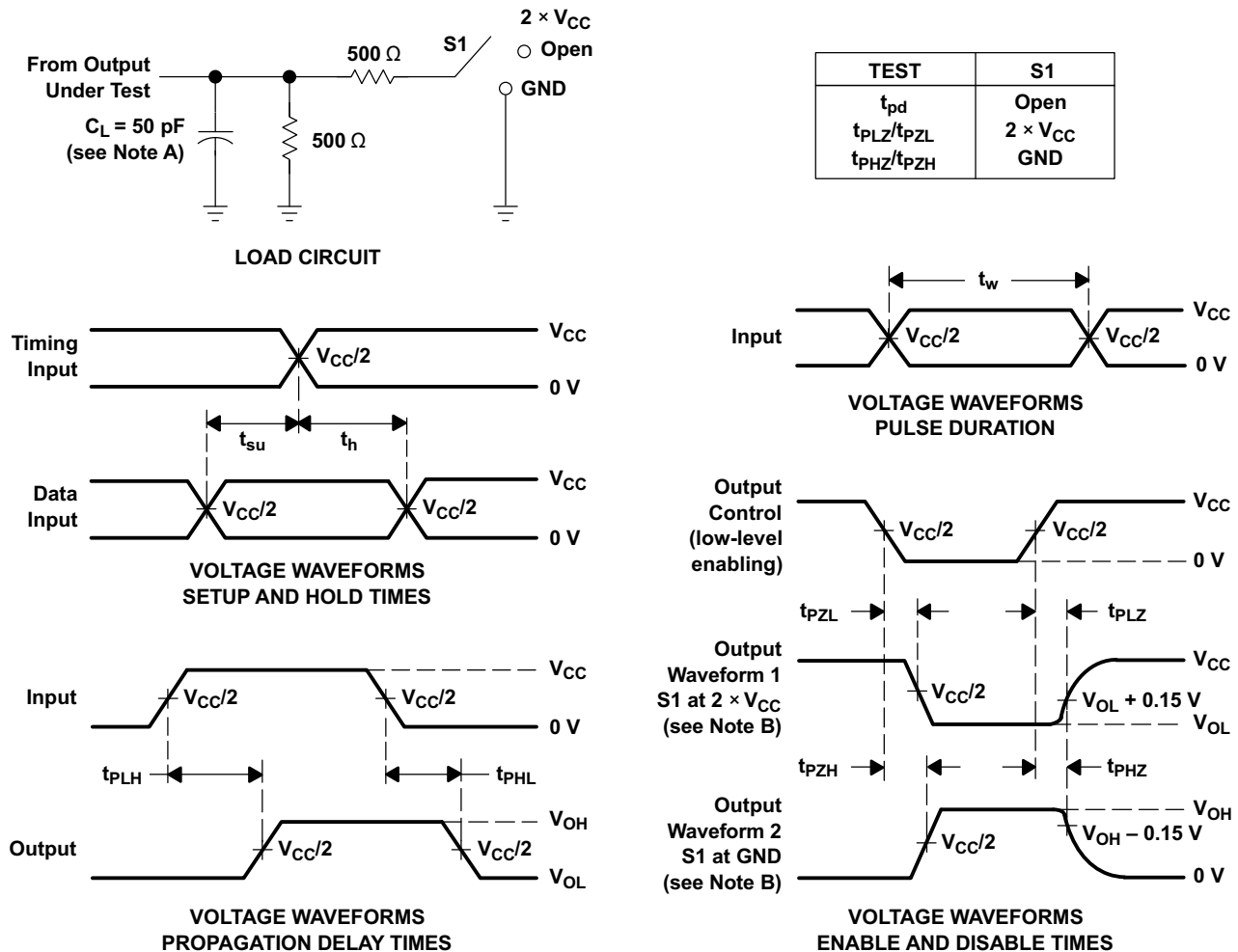
### 7.1 A Port ( $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ and $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ )



- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2 \text{ ns}$ ,  $t_f \leq 2 \text{ ns}$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

**Figure 7-1. Load Circuit and Voltage Waveforms**

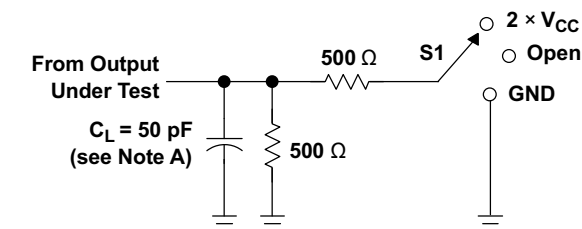
## 7.2 B Port ( $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ and $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ )



- $C_L$  includes probe and jig capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2 \text{ ns}$ ,  $t_f \leq 2 \text{ ns}$ .
- The outputs are measured one at a time, with one transition per measurement.
- $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- All parameters and waveforms are not applicable to all devices.

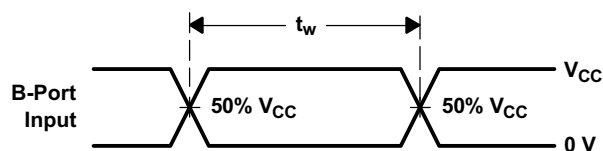
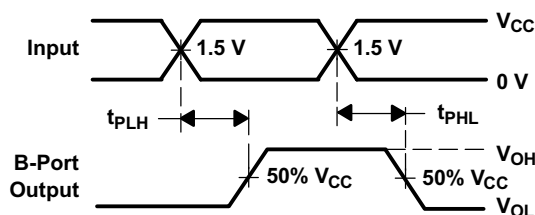
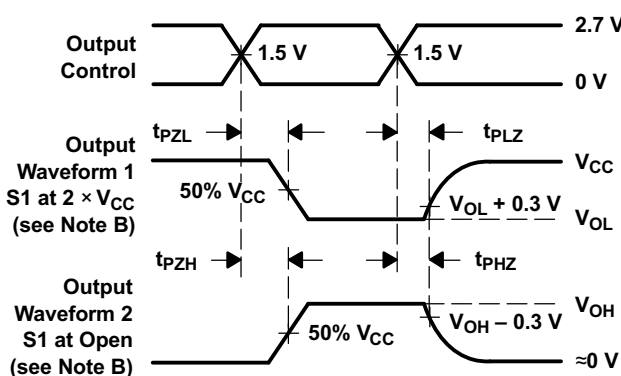
**Figure 7-2. Load Circuit and Voltage Waveforms**

### 7.3 B Port ( $V_{CCA} = 3.6\text{ V}$ and $V_{CCB} = 5.5\text{ V}$ )



LOAD CIRCUIT

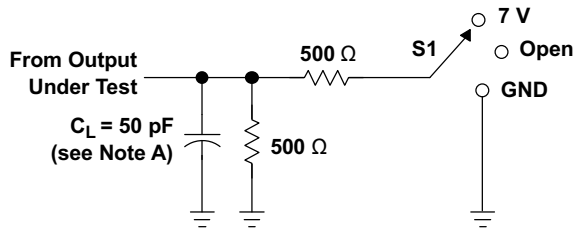
| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | Open              |

VOLTAGE WAVEFORMS  
PULSE DURATIONVOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
NONINVERTING OUTPUTSVOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

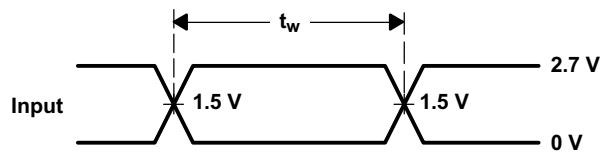
Figure 7-3. Load Circuit and Voltage Waveforms

## 7.4 A and B Port ( $V_{CCA}$ and $V_{CCB} = 3.6\text{ V}$ )

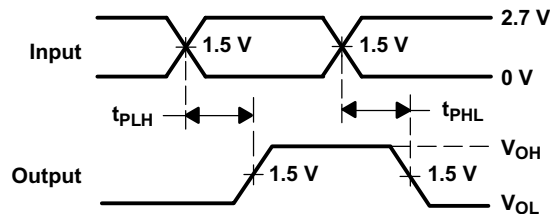


LOAD CIRCUIT

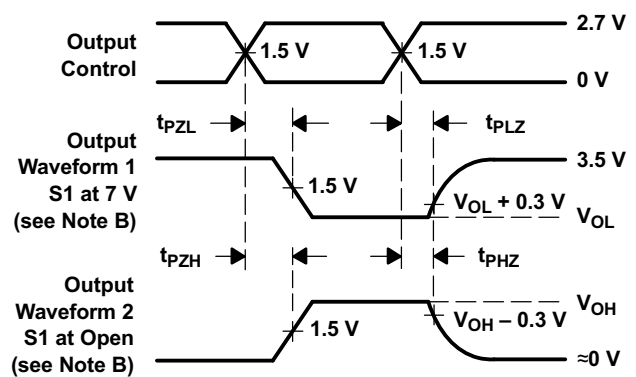
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 7 V  |
| $t_{PHZ}/t_{PZH}$ | Open |



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- $C_L$  includes probe and jig capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .
- The outputs are measured one at a time, with one transition per measurement.
- All parameters and waveforms are not applicable to all devices.

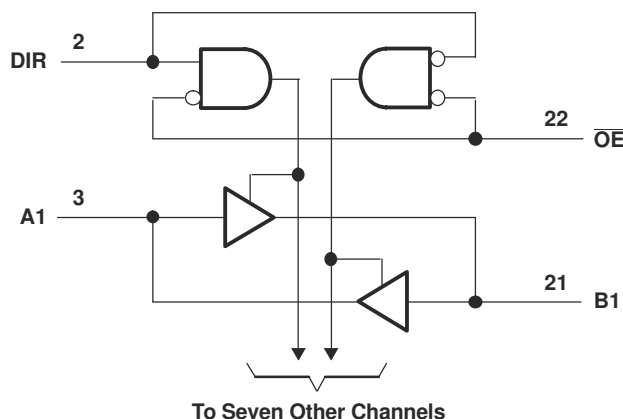
**Figure 7-4. Load Circuit and Voltage Waveforms**

## 8 Detailed Description

### 8.1 Overview

The SN74LVCC3245A device is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input can be used to disable the device so the buses are effectively isolated. The control circuitry (DIR,  $\overline{OE}$ ) is powered by  $V_{CCA}$ .

### 8.2 Functional Block Diagram



### 8.3 Feature Description

This device is a bidirectional level translator designed to operate from 2.3 V to 3.6 V on Port A and 3 V to 5.5 V on B port. The control inputs recommended operating specifications are referenced with respect to  $V_{CCA}$  Voltage.

### 8.4 Device Functional Modes

Table 8-1 lists the functional modes of the SN74LVCC3245A.

**Table 8-1. Function Table (Each Transceiver)**

| INPUTS          |     | OPERATION       |
|-----------------|-----|-----------------|
| $\overline{OE}$ | DIR |                 |
| L               | L   | B data to A bus |
| L               | H   | A data to B bus |
| H               | X   | Isolation       |

## Application and Implementation

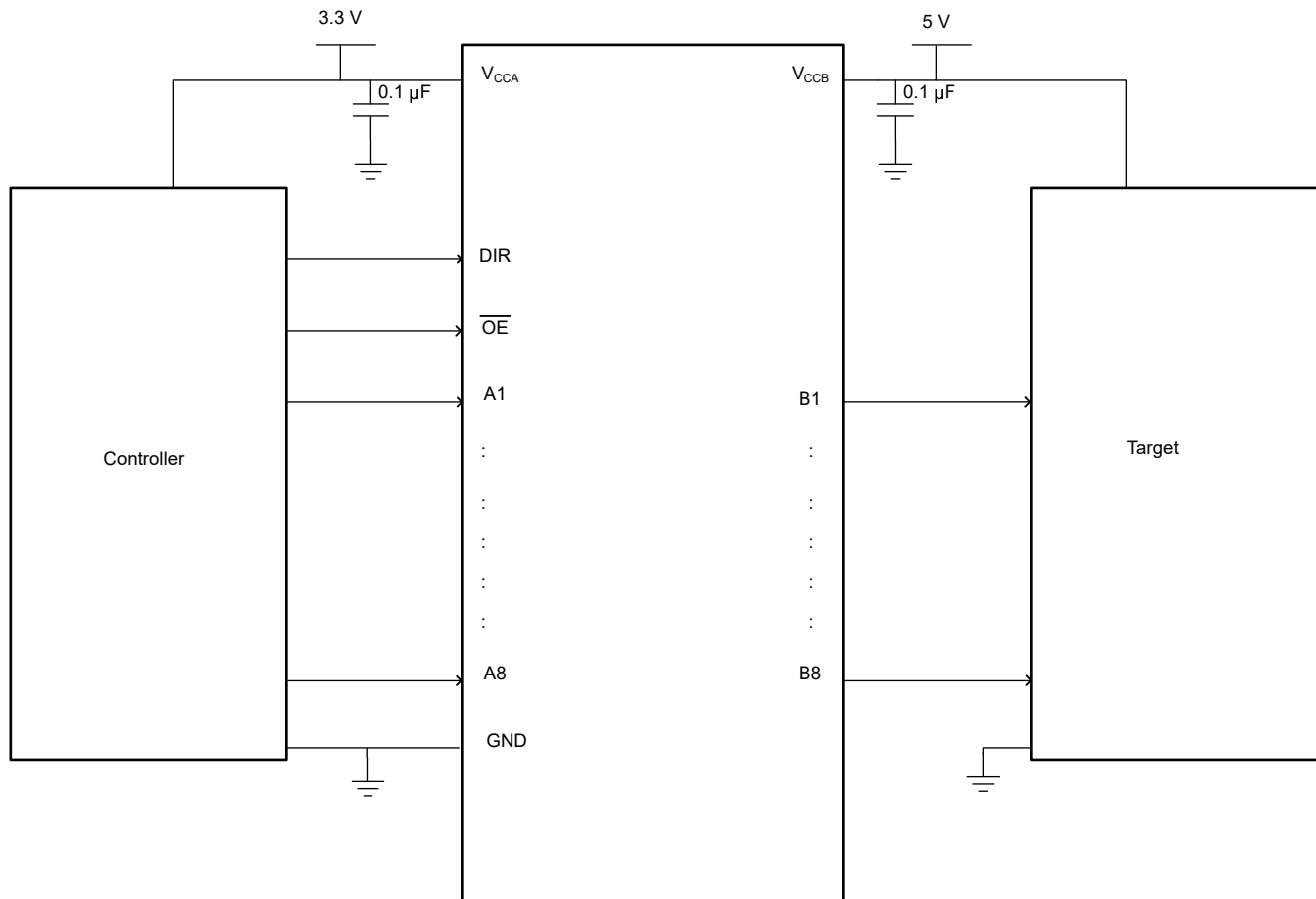
### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The SN74LVCC3245A device is a bidirectional level translator designed to operate from 2.3 V to 3.6 V on Port A and 3 V to 5.5 V on B port and designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input.

### 9.2 Typical Application



**Figure 9-1. Typical Application**

#### 9.2.1 Design Requirements

This device can be used as bidirectional level translator depending on the DIR pin. The application describes the level translation of controller with signals at 3.3 V to target operating at 5 V. The  $\overline{\text{OE}}$  pin is low and DIR pin is 3.3-V high.

## 9.2.2 Detailed Design Procedure

Use the procedure that follows for the design:

1. Recommended Input Conditions
  - Rise time and fall time specs. See ( $\Delta t/\Delta V$ ) in the [Recommended Operating Conditions](#) table.
  - Specified high and low levels. See ( $V_{IH}$  and  $V_{IL}$ ) in the [Recommended Operating Conditions](#) table.
  - Inputs are overvoltage tolerant allowing them to go as high as ( $V_I$  max) in the [Recommended Operating Conditions](#) table at any valid  $V_{CC}$ .
2. Absolute Maximum Output Conditions
  - Load currents should not exceed ( $I_O$  max) per output and should not exceed total current (continuous current through  $V_{CC}$  or GND) for the part. These limits are located in the [Absolute Maximum Ratings](#) table.
  - All the voltages on A and B ports should not exceed above  $V_{CCA}$  or  $V_{CCB}$  to prevent the biasing of Electrostatic discharge (ESD) diodes.

## 9.2.3 Application Curve

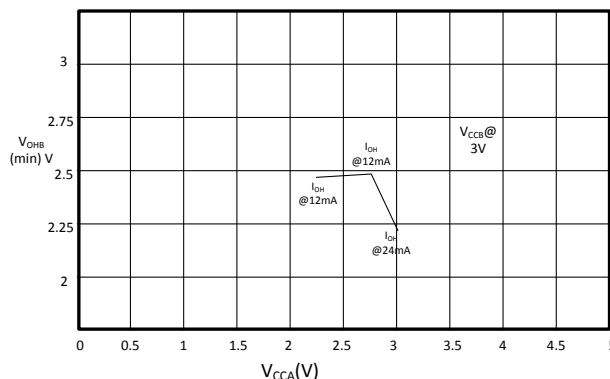


Figure 9-2.  $V_{OH(min)}$  vs  $V_{CCA}$

## 9 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the [Recommended Operating Conditions](#) table.

Each  $V_{CC}$  pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, a 0.1- $\mu$ F capacitor is recommended and if there are multiple  $V_{CC}$  pins then 0.01- $\mu$ F or 0.022- $\mu$ F capacitor is recommended for each power pin. It is ok to parallel multiple bypass capacitors to reject different frequencies of noise. 0.1- $\mu$ F and 1- $\mu$ F capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

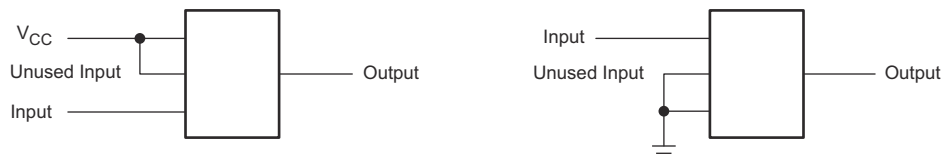


## 10 Layout

### 10.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float. In many cases, functions or parts of functions of digital logic devices are unused; for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$  whichever make more sense or is more convenient.

### 10.2 Layout Example



**Figure 10-1. Layout Example**

### 10.3 Power-Up Considerations

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device terminals. To guard against such power-up problems, take these precautions:

1. Connect ground before any supply voltage is applied.
2. Power up the control side of the device ( $V_{CCA}$  for all four of these devices).
3. Tie  $\overline{OE}$  to  $V_{CCA}$  with a pullup resistor so that it ramps with  $V_{CCA}$ .
4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with  $V_{CCA}$ . Otherwise, keep DIR low.

For more information, refer to [Voltage-Level-Translation Devices](#) application note.

## 11 Device and Documentation Support

### 11.1 Documentation Support

#### 11.1.1 Related Documentation

For related documentation, see the following:

- Texas Instruments, [Implications of Slow or Floating CMOS Inputs](#)
- Texas Instruments, [Voltage-Level-Translation Devices](#)

### 11.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 11.4 Trademarks

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### 11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser based versions of this data sheet, refer to the left hand navigation.

## PACKAGING INFORMATION

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74LVCC3245ADBQR</a>  | Active        | Production           | SSOP (DBQ)   24 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ADBQR.B                | Active        | Production           | SSOP (DBQ)   24 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | LVCC3245A           |
| <a href="#">SN74LVCC3245ADBR</a>   | Active        | Production           | SSOP (DB)   24  | 2000   LARGE T&R      | Yes         | NIPDAU   NIPDAU                      | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245ADBR.A                 | Active        | Production           | SSOP (DB)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245ADBR.B                 | Active        | Production           | SSOP (DB)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245ADBRE4                 | Active        | Production           | SSOP (DB)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245ADBRG4                 | Active        | Production           | SSOP (DB)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| <a href="#">SN74LVCC3245ADW</a>    | Active        | Production           | SOIC (DW)   24  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ADW.B                  | Active        | Production           | SOIC (DW)   24  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ADWE4                  | Active        | Production           | SOIC (DW)   24  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ADWG4                  | Active        | Production           | SOIC (DW)   24  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| <a href="#">SN74LVCC3245ADWR</a>   | Active        | Production           | SOIC (DW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ADWR.B                 | Active        | Production           | SOIC (DW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| <a href="#">SN74LVCC3245ADWRG4</a> | Active        | Production           | SOIC (DW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ADWRG4.B               | Active        | Production           | SOIC (DW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| <a href="#">SN74LVCC3245ANSR</a>   | Active        | Production           | SOP (NS)   24   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| SN74LVCC3245ANSR.B                 | Active        | Production           | SOP (NS)   24   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVCC3245A           |
| <a href="#">SN74LVCC3245APW</a>    | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245APW.B                  | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| <a href="#">SN74LVCC3245APWR</a>   | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245APWR.A                 | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245APWRE4                 | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245APWRG4                 | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| <a href="#">SN74LVCC3245APWT</a>   | Active        | Production           | TSSOP (PW)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245APWT.B                 | Active        | Production           | TSSOP (PW)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |
| SN74LVCC3245APWTG4                 | Active        | Production           | TSSOP (PW)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LH245A              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

**(2) Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

**(3) RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

**(4) Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN74LVCC3245A :**

- Enhanced Product : [SN74LVCC3245A-EP](#)

NOTE: Qualified Version Definitions:

- Enhanced Product - Supports Defense, Aerospace and Medical Applications

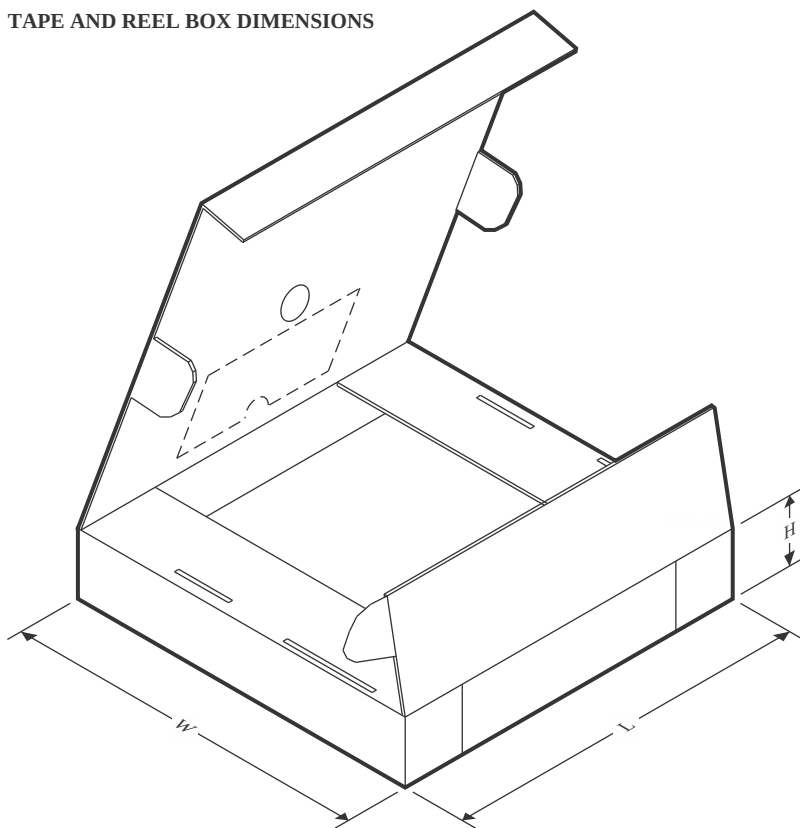
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVCC3245ADBQR  | SSOP         | DBQ             | 24   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74LVCC3245ADBR   | SSOP         | DB              | 24   | 2000 | 330.0              | 16.4               | 8.2     | 8.8     | 2.5     | 12.0    | 16.0   | Q1            |
| SN74LVCC3245ADWR   | SOIC         | DW              | 24   | 2000 | 330.0              | 24.4               | 10.75   | 15.7    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74LVCC3245ADWRG4 | SOIC         | DW              | 24   | 2000 | 330.0              | 24.4               | 10.75   | 15.7    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74LVCC3245ANSR   | SOP          | NS              | 24   | 2000 | 330.0              | 24.4               | 8.3     | 15.4    | 2.6     | 12.0    | 24.0   | Q1            |

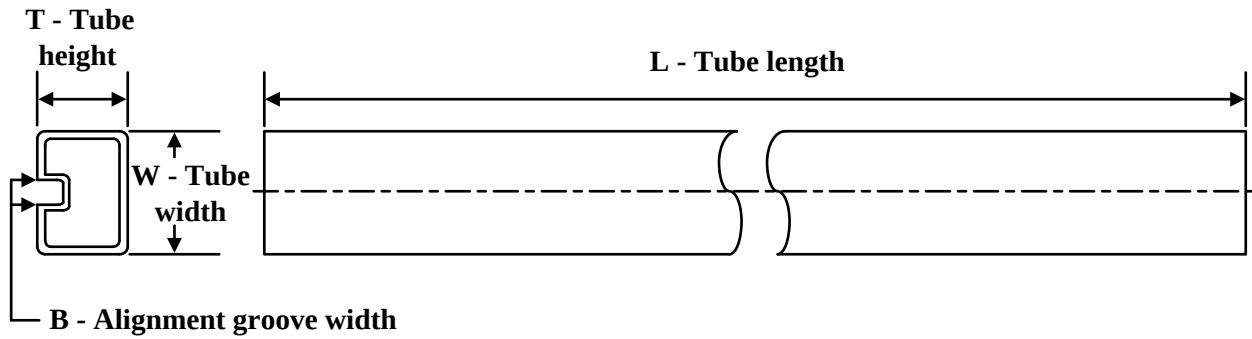
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVCC3245ADBQR  | SSOP         | DBQ             | 24   | 2500 | 353.0       | 353.0      | 32.0        |
| SN74LVCC3245ADBR   | SSOP         | DB              | 24   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LVCC3245ADWR   | SOIC         | DW              | 24   | 2000 | 350.0       | 350.0      | 43.0        |
| SN74LVCC3245ADWRG4 | SOIC         | DW              | 24   | 2000 | 350.0       | 350.0      | 43.0        |
| SN74LVCC3245ANSR   | SOP          | NS              | 24   | 2000 | 356.0       | 356.0      | 45.0        |

## TUBE

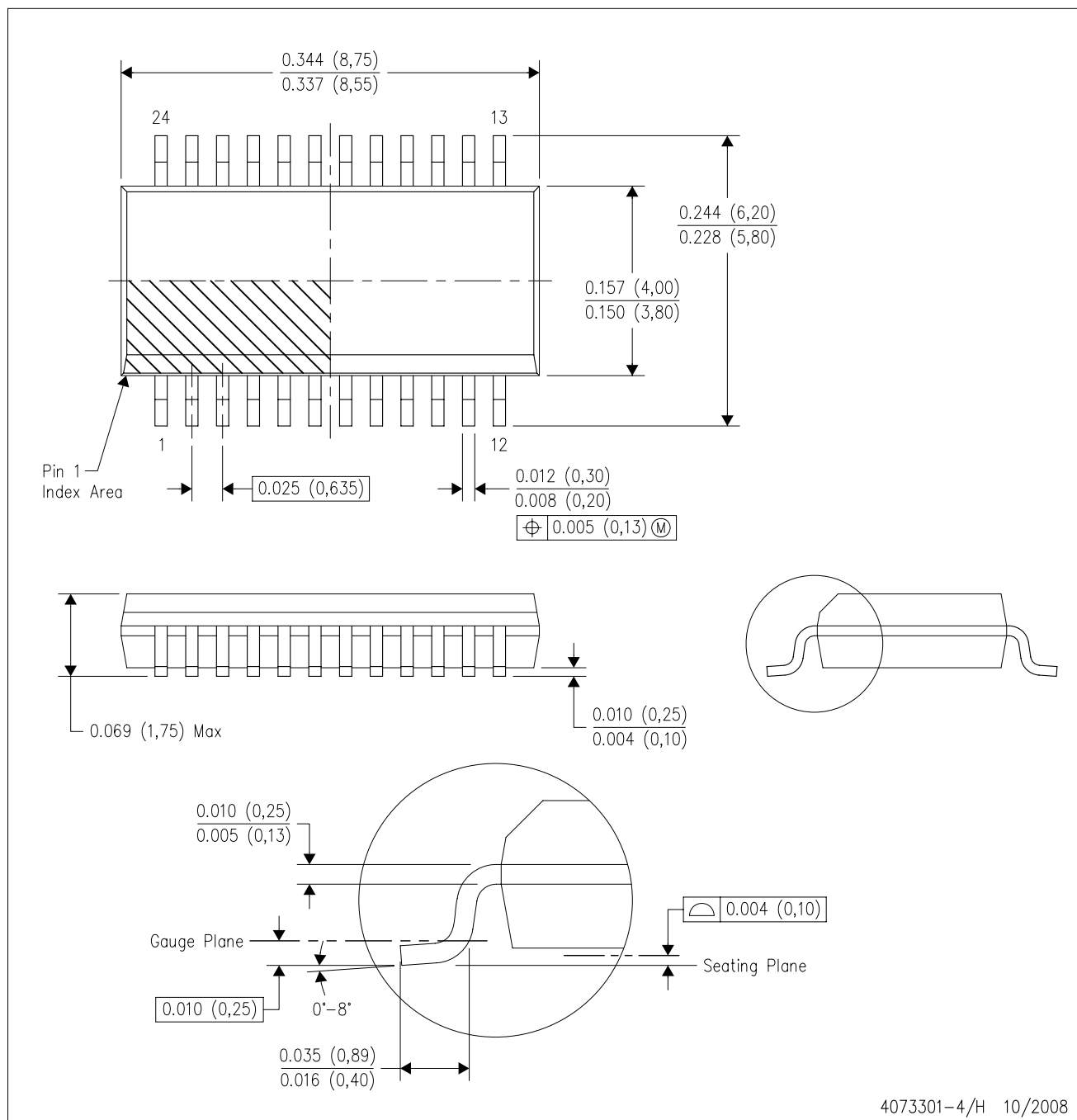


\*All dimensions are nominal

| Device            | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LVCC3245ADW   | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| SN74LVCC3245ADW.B | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| SN74LVCC3245ADWE4 | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| SN74LVCC3245ADWG4 | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| SN74LVCC3245APW   | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| SN74LVCC3245APW.B | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |

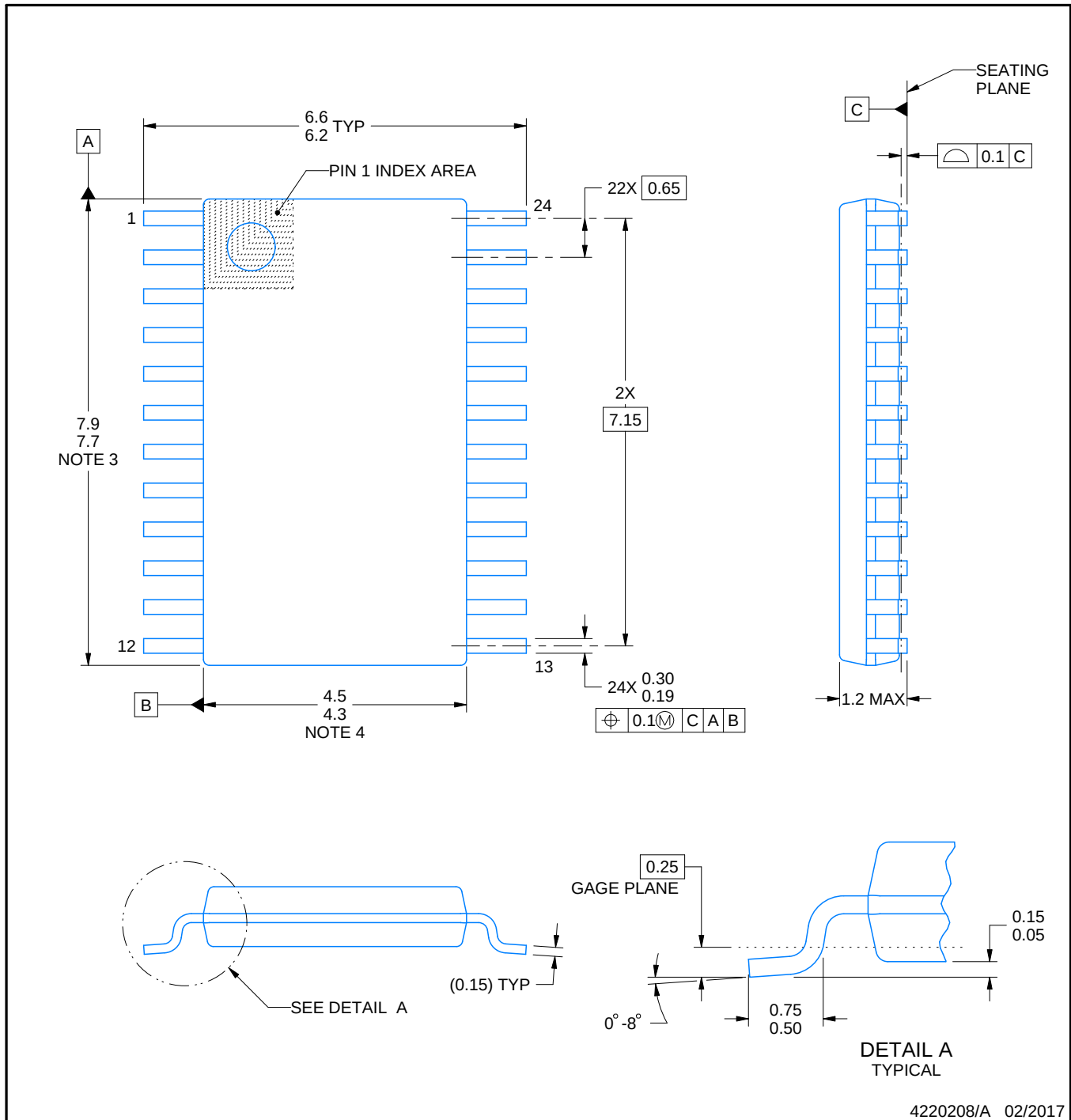
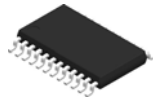
DBQ (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15) per side.
  - D. Falls within JEDEC MO-137 variation AE.





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## NOTES:

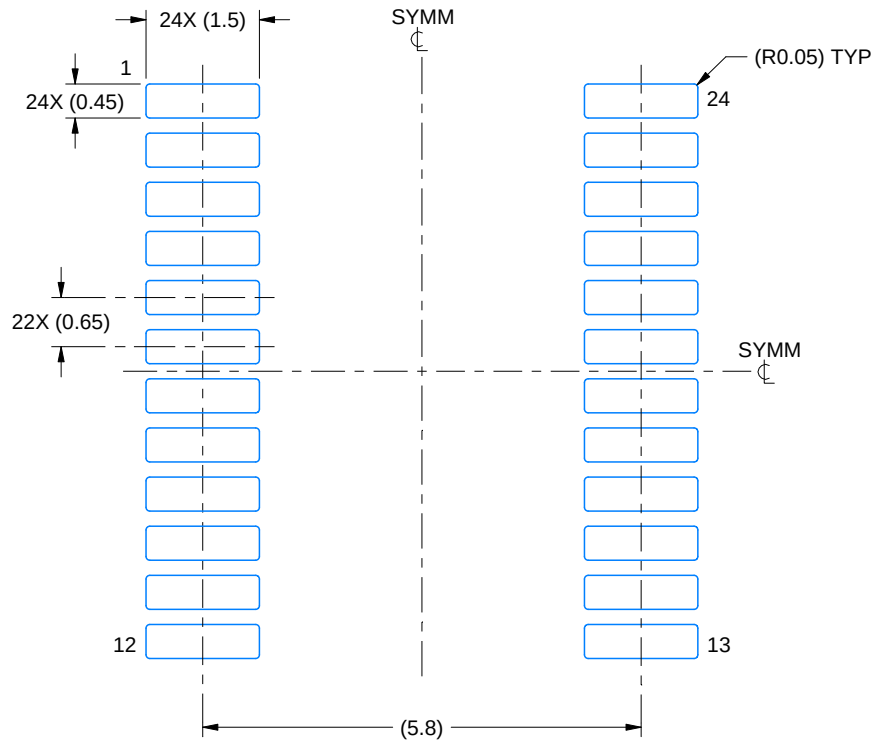
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

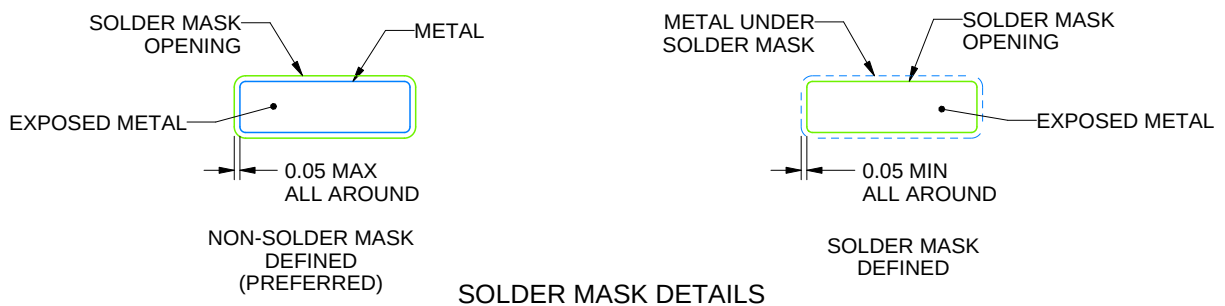
PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

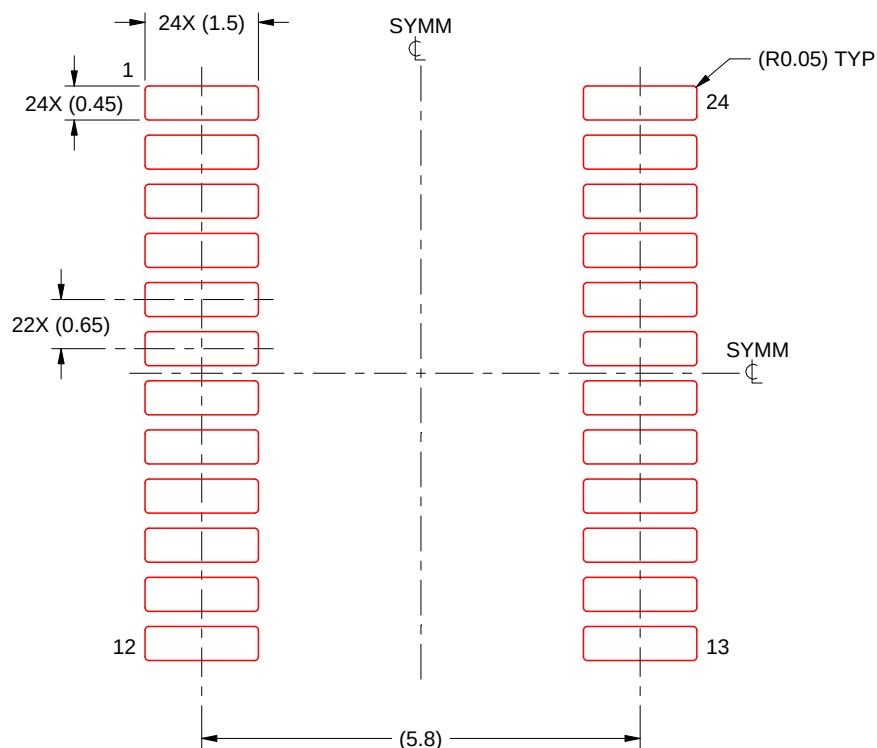
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

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NOTES: (continued)

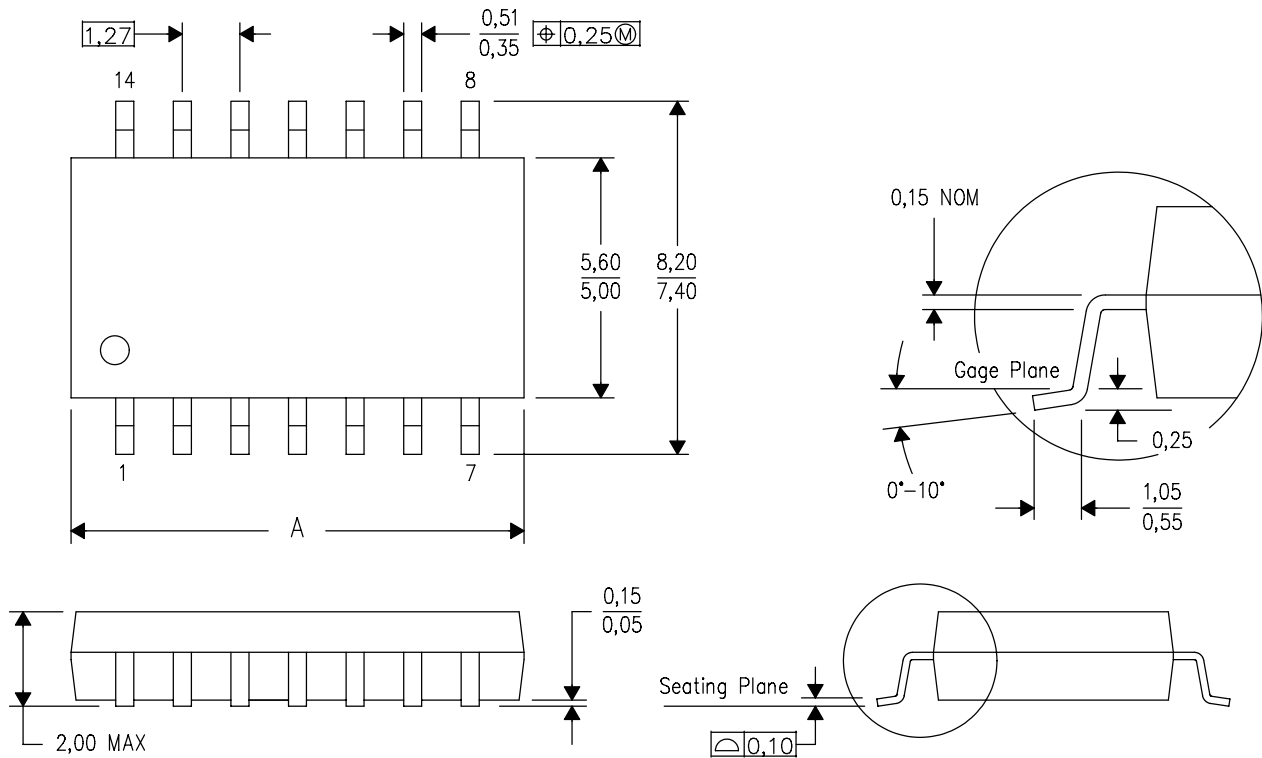
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



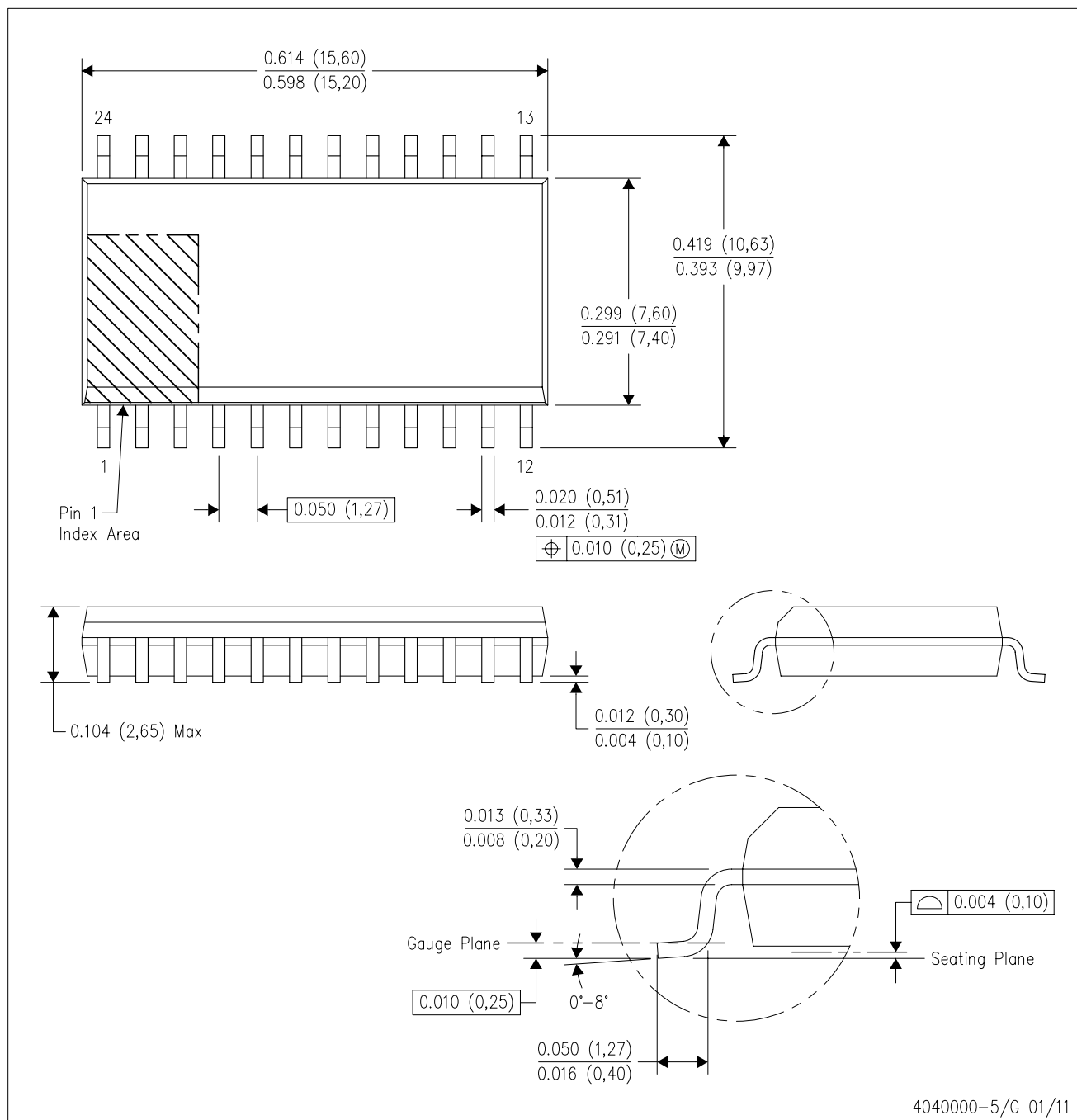
| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DW (R-PDSO-G24)

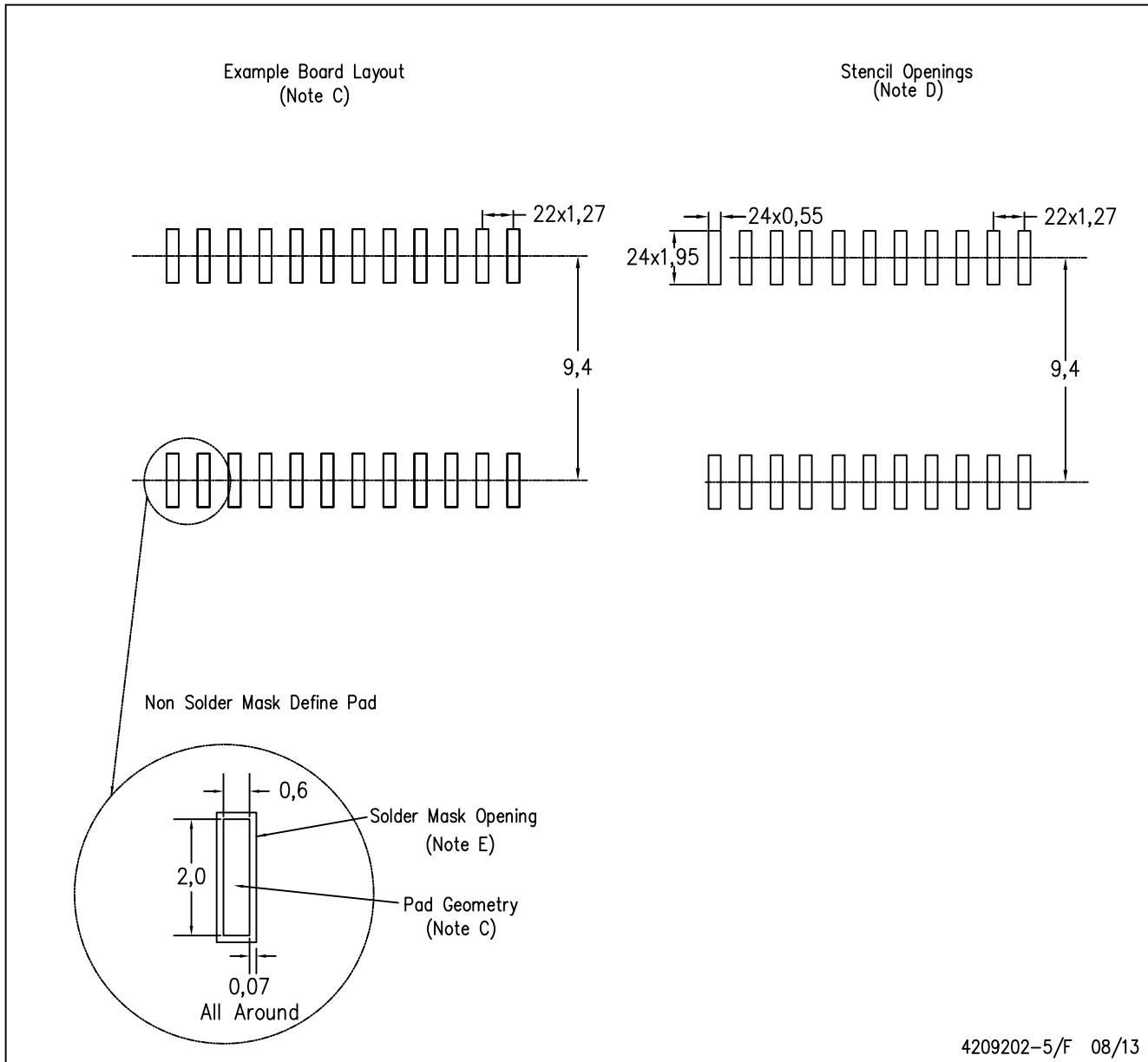
PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AD.

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE

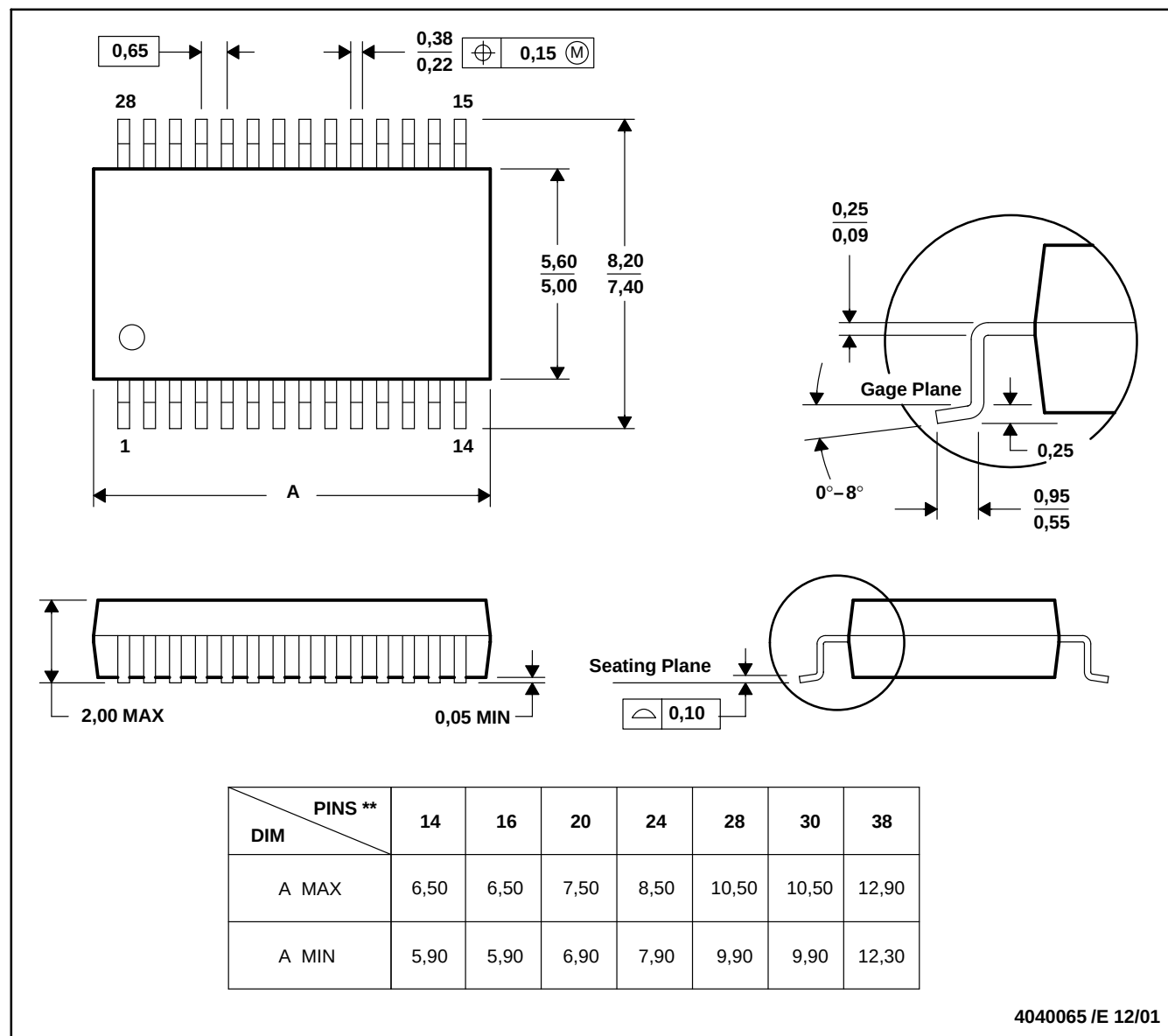


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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